

Vishay Semiconductors

Single Phase Fast Recovery Bridge (Power Modules), 60 A



SOT-227

PRODUCT SUMMARY				
I _{T(AV)}	60 A			
Туре	Modules - Bridge, Fast			

FEATURES

- Fast recovery time characteristic
- Electrically isolated base plate
- Simplified mechanical designs, rapid assembly
- UL pending
- Excellent power/volume ratio
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified for industrial and consumer level

DESCRIPTION

The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built.

MAJOR RATINGS AND CHARACTERISTICS				
SYMBOL	CHARACTERISTICS	VALUES	UNITS	
		60	А	
10	T _C	59	°C	
I _{FSM}	50 Hz	300	٨	
	60 Hz	310	~	
l ² t	50 Hz	442	- A ² s	
	60 Hz	402		
V _{RRM}		600	V	
TJ		- 55 to 150	°C	

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS						
TYPE NUMBER	VOLTAGE CODE	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} MAXIMUM AT T _J MAXIMUM		
SA60BA60	60	600	700	5		



COMPLIANT

SA60BA60

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FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum DC output current	L.	Resistive or ir	nductive load		60	А
at case temperature	10				59	°C
		t = 10 ms	No voltage	Initial T _J = T _J maximum	300	A
Maximum peak, one-cycle		t = 8.3 ms	reapplied		310	
non-repetitive forward current	IFSM	t = 10 ms	100 % V _{RRM}		250	
		t = 8.3 ms	reapplied		260	
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage reapplied		442	A ² s
		t = 8.3 ms			402	
		t = 10 ms	100 % V _{RRM}		313	
		t = 8.3 ms	reapplied		284	
Maximum I ² \sqrt{t} for fusing	l²√t	l^2t for time t_x = $l_2 \sqrt{t} \; x \; \sqrt{t_x}; 0.1 \leq t_x \leq 10$ ms, V_{RRM} = 0 V		4.4	kA²√s	
Value of threshold voltage	V _{F(TO)}	T _J maximum		0.914	V	
Forward slope resistance	r _t			10.5	mΩ	
Maximum forward voltage drop	V _{FM}	T _J = 25 °C, I _F	$T_{\rm J} = 25~{\rm ^{\circ}C}, \ I_{\rm FM} = 30~A_{\rm pk}$ $T_{\rm J} = T_{\rm J}$ maximum, $I_{\rm FM} = 30~A_{\rm pk}$ $t_{\rm p} = 400~\mu {\rm s}$		1.33	
		$T_J = T_J maxin$			1.23	V
RMS isolation voltage base plate	V _{INS}	f = 50 Hz, t = 1 s		3000		

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Reverse recovery time t _{rr}		$T_J = 25 \ ^{\circ}C, I_F = 20 \ A, V_R = 30 \ V,$ $dI_F/dt = 100 \ A/\mu s$	160		· •	
	۲rr	T_J = 125 °C, I _F = 20 A, V _R = 30 V, dI _F /dt = 100 A/µs	250	115		
Reverse recovery current	I _{rr}	T_J = 25 °C, I _F = 20 A, V _R = 30 V, dI _F /dt = 100 A/µs	10	A		
		T_J = 125 °C, I _F = 20 A, V _R = 30 V, dI _F /dt = 100 A/µs	15		$\frac{dI_{R}}{dt}$	
Reverse recovery charge	Q _{rr}	$T_J = 25 \ ^{\circ}C, I_F = 20 \ A, V_R = 30 \ V,$ $dI_F/dt = 100 \ A/\mu s$	1.20			
		T_J = 125 °C, I _F = 20 A, V _R = 30 V, dI _F /dt = 100 A/µs	2.90	nc		
Snap factor, typical	S	T _J = 25 °C	0.6	-		

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Junction and storage temperature range	T _J , T _{Stg}		- 55 to 150	°C
Maximum thermal resistance junction to case per bridge	R _{thJC}		0.30	°C 111
Typical thermal resistance, case to heatsink per module	R _{thCS}	Mounting surface, smooth, flat and greased	0.05	0/10
Approximate weight			30	g
Mounting torque ± 10 %		Bridge to heatsink	1.3	Nm
Case style			SOT-22	27

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For technical questions within your region, please contact one of the following: indmodules@vishay.com

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Fig. 1 - Typical Forward Voltage Drop Characteristics

Fig. 3 - Forward Power Loss Characteristics



Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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Fig. 5 - Recovery Time Characteristics, $T_J = 25 \ ^{\circ}C$









Fig. 8 - Recovery Charge Characteristics, $T_J = 150 \ ^\circ C$





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Fig. 11 - Reverse Recovery Parameter Test Circuit



 $Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$

(2) I_{RRM} - peak reverse recovery current

(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going $\rm I_F$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 12 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Single phase bridge	В				

LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?95036		



Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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